

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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AN304 Through-hole IRED/ ϕ 5 Type

Features

Package	ϕ 5 type, Water clear epoxy
Product features	 Total Output Power: 9mW TYP. (I_F=50mA) Lead-free soldering compatible RoHS compliant
Peak Wavelength	950nm
Half Intensity Angle	50 deg.
Die materials	GaAs
Rank grouping parameter	Sorted by radiant intensity per rank taping
Soldering methods	TTW (Through The Wave) soldering and manual soldering **Please refer to Soldering Conditions about soldering.
ESD	2kV (HBM)
Packing	Bulk : 200pcs(MIN.)

Recommended Applications

Electric Household Appliances, OA/FA, PC/Peripheral Equipment, Other General Applications





AN304
Through-hole IRED/ \$\phi\$ 5 Type

Absolute Maximum Ratings

(Ta=25℃)

Item	Symbol	Absolute Maximum Ratings	Unit
Power Dissipation	Pd	150	mW
Forward Current	I _F	100	mA
Pulse Forward Current **1	I _{FRM}	1,000	mA
Derating (Ta=25℃ or higher)	⊿I _F	1.33	mA/℃
	⊿I _{FRM}	13.3	mA/℃
Reverse Voltage	V_R	5	V
Operating Temperature	T_{opr}	-30~+85	င
Storage Temperature	T _{stg}	-30~+100	င

%1 IFRM Measurement condition: Pulse Width≤100 μ s, Duty≤1/100

Electro-Optical Characteristics

(Ta=25℃)

Item		Cymah al	Characteristics		Unit
nem	Conditions	Symbol			Onit
Famous and Maltana	I 50 A	V _F	TYP.	1.3	v
Forward Voltage	I _F =50mA		MAX.	1.5	v
Reverse Current	V _R =5V	I _R	MAX.	10	μΑ
D P (1 ()		I _E	MIN.	6	mW/sr
Radiant Intensity	I _F =50mA		TYP.	15	
Total Output Power	I _F =50mA	Po	TYP.	9	mW
Peak Wavelength	I _F =50mA	λ,	TYP.	950	nm
Spectral Half-width	I _F =50mA	Δλ	TYP.	45	nm
Half Intensity Angle	I _F =50mA	2 θ 1/2	TYP.	50	deg.
C 1 55 F	I _F =50mA _{DC} ±5mA,	fc	MIN.	-	MHz
Cut-off Frequency	-3db from 0.1MHz		TYP.	0.5	
Response Time	I _F =50mA	tr/tf	TYP.	700	ns





Radiant Intensity Rank

(Ta=25℃)

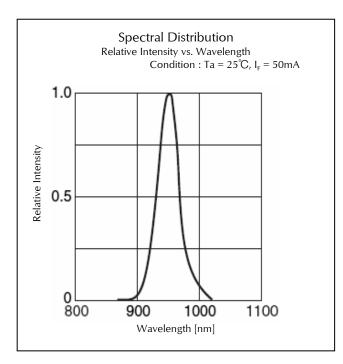
Rank	l _E (m\	Condition	
Kalik	MIN.	MAX.	Condition
A	6.0	12.0	
В	8.4	16.8	
C	12.0	24.0	I _F = 50mA
D	16.8	33.6	
E	24.0	-	

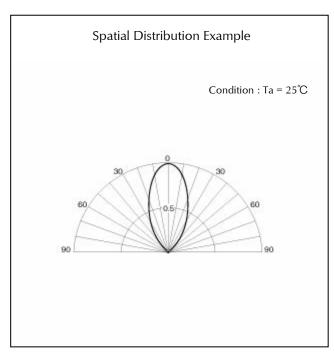
 $[\]ensuremath{\mathbb{X}}$ Please contact our sales staff concerning rank designation.

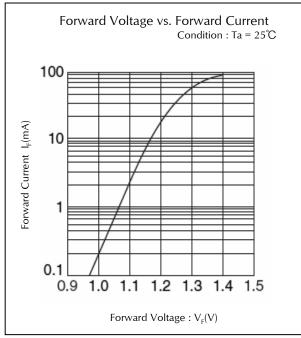


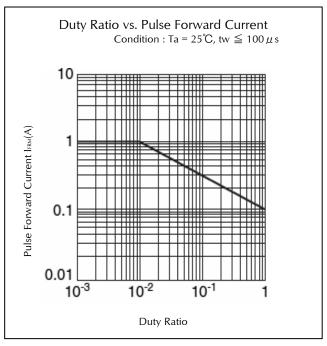


Technical Data





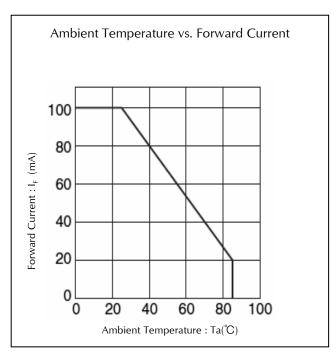


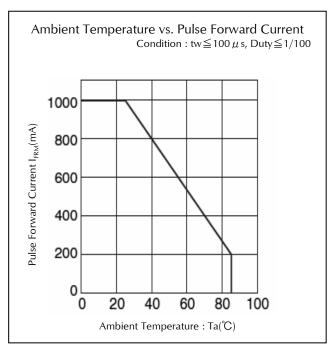


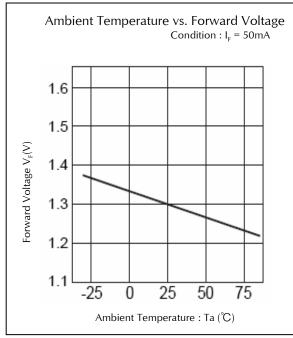


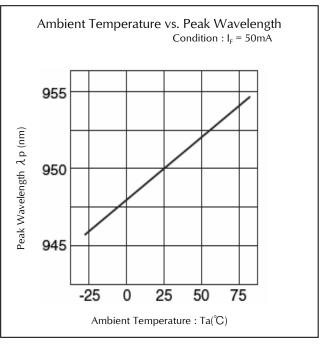


Technical Data





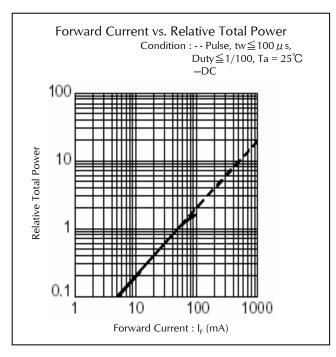


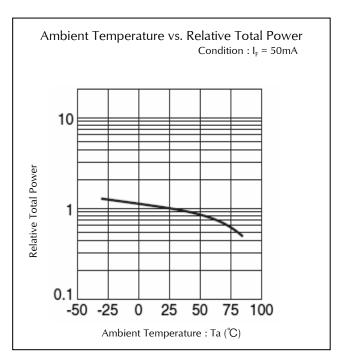


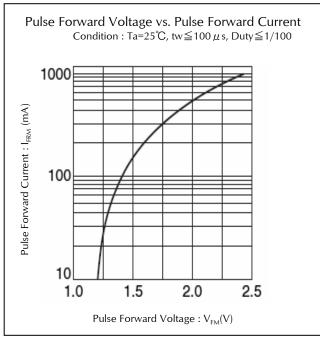




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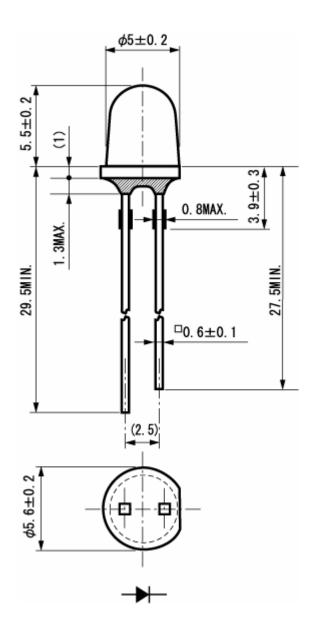






Package Dimensions

(Unit: mm)







TTW (Through The Wave) soldering Conditions

Pre-heating	100 ℃	(MAX.) Resin surface temperature
Solder Bath Temp.	265 ℃	(MAX.)
Dipping Time	5 s	(MAX.)
Position	At least 3.	0 mm away from the root of lead

- 1) The dip soldering process shall be twice maximum.
- 2) The product shall be cooled to normal temperature before the second dipping process. **The detail is described to LED and Photodetector handling precautions of home page:

 "Mounting through-hole Type Devices" and "Soldering", and use it after the confirmation, please.

Manual Soldering Conditions

Iron tip temp.	400 ℃	(MAX.) (30 W Max.)	
Soldering time and frequency	3 s 1 time	(MAX.) (MAX.)	
Position	At least 3.0 mm away from the root of lead		

%The detail is described to LED and Photodetector handling precautions of home page: "Mounting through-hole Type Devices" and "Soldering", and use it after the confirmation, please.





Reliability Testing Result

Reliability Testing Result	Applicable Standard	Testing Conditions	Duration	Failure
Room Temp. Operating Life	EIAJ ED- 4701/100(101)	Ta = 25°C, IF = Maxium Rated Current	1,000 h	0/25
Resistance to Soldering Heat	EIAJ ED- 4701/300(302)	265±5℃, 3mm from package base	10s	0/25
Temperature Cycling	EIAJ ED- 4701/100(105)	Minimum Rated Storage Temperature(30min) Normal Temperature(15min) Maximum Rated Storage Temperature(30min) Normal Temperature(15min)	5 cycles	0/25
Wet High Temp. Storage Life	EIAJ ED- 4701/100(103)	$Ta = 60 \pm 2$ °C, RH = 90 ± 5 %	1,000 h	0/25
High Temp. Storage Life	EIAJ ED- 4701/200(201)	Ta = Maximum Rated Storage Temperature	1,000 h	0/25
Low Temp. Storage Life	EIAJ ED- 4701/200(202)	Ta = Minimum Rated Storage Temperature	1,000 h	0/25
Lead Tension	EIAJ ED- 4701/400(401)	10N,1time (□0.4 and Flat Package : 5N)	10s	0/10
Vibration, Variable Frequency	EIAJ ED- 4701/400(403)	98.1m/s ² (10G), 100 ~ 2KHz sweep for 20min., XYZ each direction	2 h	0/10

Failure Criteria

Items	Symbols	Conditions	Failure criteria
Luminous Intensity	lv	IF Value of each product Luminous Intensity	Testing Min. Value < Spec. Min. Value x 0.5
Forward Voltage	VF	IF Value of each product Forward Voltage	Testing Max. Value ≧ Spec. Max. Value x 1.2
Reverse Current	I R	Vr = Maximum Rated Reverse Voltage V	Testing Max. Value ≧ Spec. Max. Value x 2.5
Cosmetic Appearance	-	-	Occurrence of notable decoloration, deformation and cracking





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